

P-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
- 60	0.165 at V _{GS} = - 10 V	- 3.2	23 nC			
- 00	0.215 at V _{GS} = - 4.5 V	- 1.0	23110			

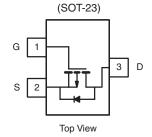
FEATURES

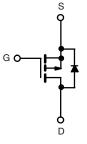
- DT-Trench Power MOSFET
- 100 % R_g Tested

APPLICATIONS

- Load Switch
- DC/DC Converter







P-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	- 60	v	
Gate-Source Voltage		V _{GS}	± 20	V	
	T _C = 25 °C		- 3.2		
Continuous Drain Current (T. 150 °C)	T _C = 70 °C		- 2.1		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	- 1.9 ^{b, c}		
	T _A = 70 °C		- 1.1 ^{b, c}	А	
Pulsed Drain Current		I _{DM}	- 10		
	T _C = 25 °C		- 3.2		
Continous Source-Drain Diode Current	T _A = 25 °C	I _S	- 1.3 ^{b, c}		
	T _C = 25 °C		1.2		
Mauinum Dauran Diagin atian	T _C = 70 °C		0.8		
Maximum Power Dissipation	T _A = 25 °C	P _D	0.65 ^{b, c}	W	
	T _A = 70 °C	1	0.4 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter	_	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	$t \le 5 s$	R _{thJA}	85	110	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	45	55	0/10	

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

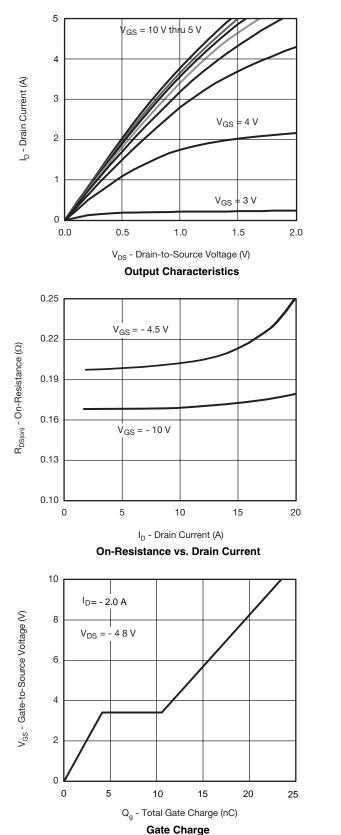
d. Maximum under steady state conditions is 166 $^{\circ}\text{C/W}.$

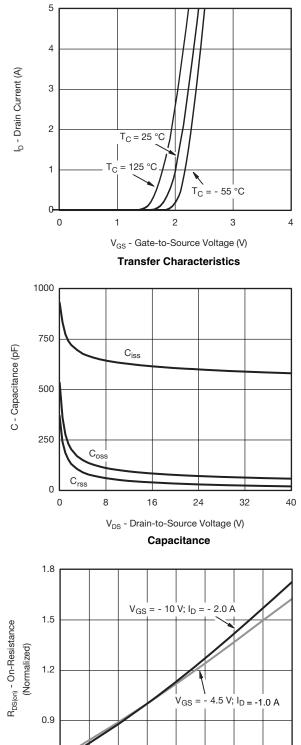
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		·			•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$ I _D = - 250 µA			- 40		m\//°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$1D = -200 \mu A$		4.8		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 1.2		- 2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zava Cata Valtaga Dvain Current	I _{DSS}	V _{DS} = - 48 V, V _{GS} = 0 V		- 1			
Zero Gate Voltage Drain Current		$V_{DS} = -48 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \leq$ - 5 V, V_{GS} = - 10 V	- 3.2			А	
		$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -2.0 \text{ A}$		165	200	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 1.0 A		215	260		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 48 V, I _D = - 2.0 A		10		S	
Dynamic ^b				I	1		
Input Capacitance	C _{iss}			635		pF	
Output Capacitance	C _{oss}	V _{DS} = - 48 V, V _{GS} = 0 V, f = 1 MHz		106			
Reverse Transfer Capacitance	C _{rss}	1		68			
	Qg	$V_{DS} = -48$ V, $V_{GS} = -10$ V, $I_{D} = -2.0$ A	23				
Total Gate Charge				12			
Gate-Source Charge	Q _{gs}	$V_{DS} = -48 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -1.0 \text{ A}$		2.5		nC	
Gate-Drain Charge	Q _{gd}			3.2			
Gate Resistance	R _g	f = 1 MHz		4.3		Ω	
Turn-On Delay Time	t _{d(on)}			18			
Rise Time	t _r	V_{DD} = - 48 V, R_{L} = 8 Ω		10		- ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 1.0 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		41			
Fall Time	t _f	1 1		13			
Turn-On Delay Time	t _{d(on)}			10			
Rise Time	t _r	$V_{DD} = -48 \text{ V}, \text{ R}_{1} = 8 \Omega$		6			
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 2.0 Å, V_{GEN} = - 10 V, R_g = 1 Ω		33			
Fall Time	t _f	1		9			
Drain-Source Body Diode Characteristic	s	<u> </u>				L	
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 3.2	^	
Pulse Diode Forward Current	I _{SM}				- 10	A	
Body Diode Voltage	V_{SD}	I _S = - 2.0 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			25		ns	
Body Diode Reverse Recovery Charge	Q _{rr}			32		nC	
Reverse Recovery Fall Time	ta	$I_F = -2.0 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		10			
Reverse Recovery Rise Time t _t		1 1		7		ns	

Notes:

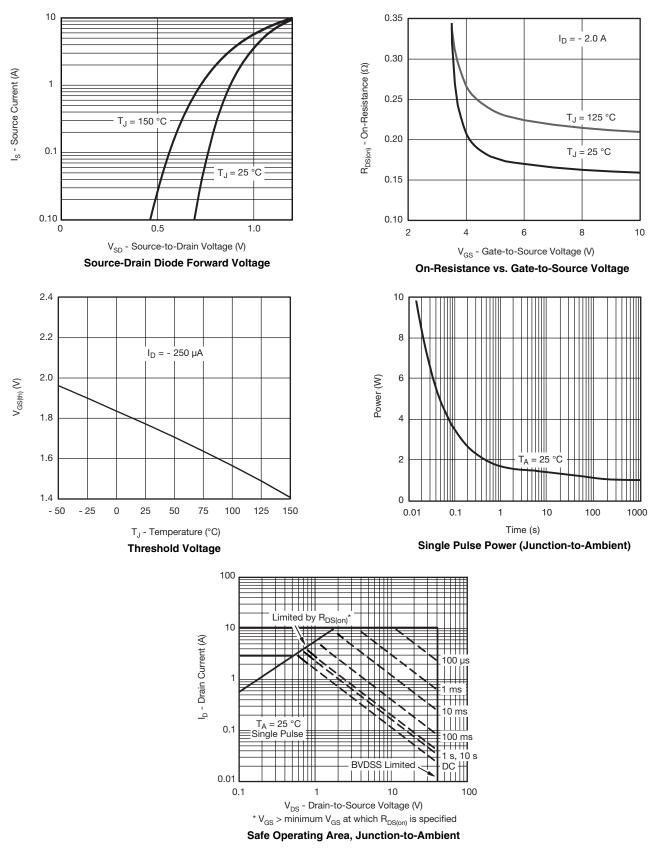
a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

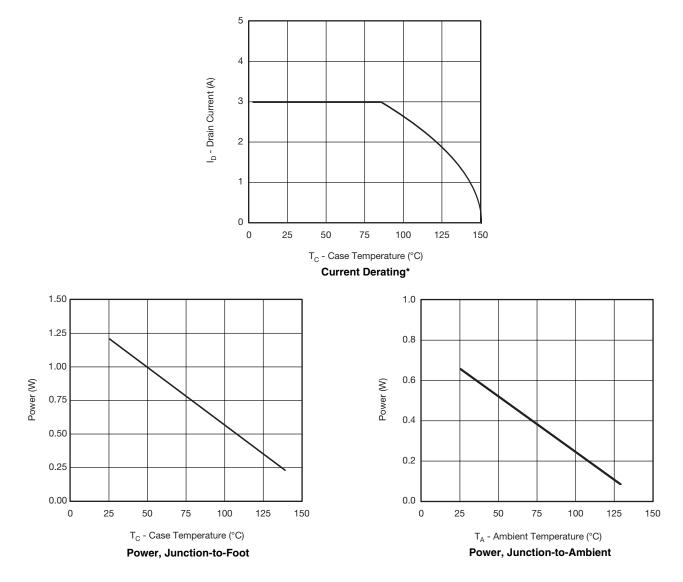
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





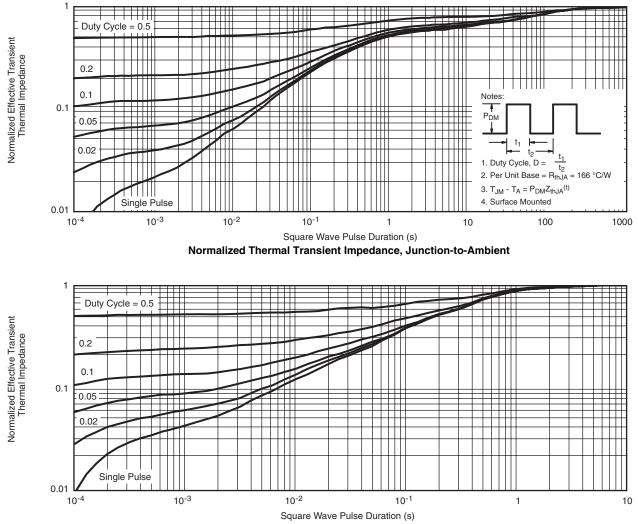
0.6 L - 50





* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

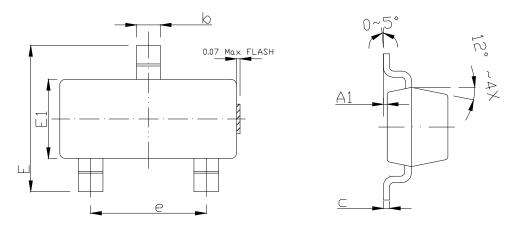


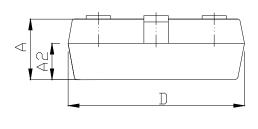


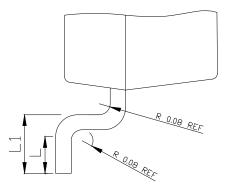
Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 PACKAGE OUTLINE







COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

CVMDOL	MILLIMETER				
SYMBOL	MIN	NOM	MAX		
А	0.80	1.00	1.30		
A1	0.00	0.05	0.15		
b	0.25	0.40	0.55		
С	0.11 BSC				
D	2 .6 0	2.90	3.20		
Е	2.10	2.40	2.70		
E1	1.10	1.30	1.48		
е	1.90 BSC				
L	0.17	_	_		
L1	0.28	0.40	0.53		
A2	0.60 REF				



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